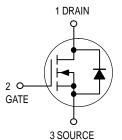
Logic Level TMOS

N-Channel Enhancement Mode

This TMOS FET is designed for high voltage, high speed switching applications such as line drivers, relay drivers, CMOS logic, microprocessor or TTL to high voltage interface and high voltage display drivers.

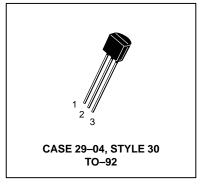
- Low Drive Requirement, V_{GS} = 3.0 V max
- Inherent Current Sharing Capability Permits Easy Paralleling of many Devices





BS108

200 VOLTS N-CHANNEL TMOS POWER FET LOGIC LEVEL



MAXIMUM RATINGS

Rating	Symbol	Value	Unit			
Drain-Source Voltage	V _{DSS}	200	Vdc			
Gate-Source Voltage	V _{GS}	±20	Vdc			
Drain Current Continuous(1) Pulsed(2)	I _D	250 500	mAdc			
Total Power Dissipation @ T _A = 25°C Derate above T _A = 25°C	PD	350 6.4	mW mW/°C			
Operating and Storage Temperature Range	TJ, T _{stg}	-55 to +150	°C			

- 1. The Power Dissipation of the package may result in a lower continuous drain current.
- 2. Pulse Test: Pulse Width $\leq 300 \,\mu\text{s}$, Duty Cycle $\leq 2.0\%$.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS			•		
Drain–Source Breakdown Voltage (V _{GS} = 0, I _D = 10 μA)	V(BR)DSS	200	_	_	Vdc
Zero Gate Voltage Drain Current (VDSS = 130 Vdc, VGS = 0)	IDSS	_	_	30	nAdc
Gate–Body Leakage Current (VGS = 15 Vdc, VDS = 0)	l _{GSSF}	_	_	10	nAdc
ON CHARACTERISTICS (2)				•	
Gate Threshold Voltage (ID = 1.0 mA, VDS = VGS)	V _{GS(th)}	0.5	_	1.5	Vdc
Static Drain—to—Source On—Resistance ($V_{GS} = 2.0 \text{ Vdc}$, $I_{D} = 50 \text{ mA}$) ($V_{GS} = 2.8 \text{ Vdc}$, $I_{D} = 100 \text{ mA}$)	r _{DS(on)}	_	_	10 8.0	Ohms
Drain Cutoff Current (VGS = 0.2 V, VDS = 70 V)	IDSX	_	_	25	μΑ
DYNAMIC CHARACTERISTICS			•	•	•
Input Capacitance (VDS = 25 V, VGS = 0, f = 1.0 MHz)	C _{iss}	_	_	150	pF
Output Capacitance (V _{DS} = 25 V, V _{GS} = 0, f = 1.0 MHz)	C _{oss}	_	_	30	pF
Reverse Transfer Capacitance (VDS = 25 V, VGS = 0, f = 1.0 MHz)	C _{rss}	_	_	10	pF
SWITCHING CHARACTERISTICS	•		•	•	
Turn-On Time (See Figure 1)	^t d(on)	_	_	15	ns
Turn–Off Time (See Figure 1)	^t d(off)	_	_	15	ns
2. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle = 2.0%.	•				

RESISTIVE SWITCHING

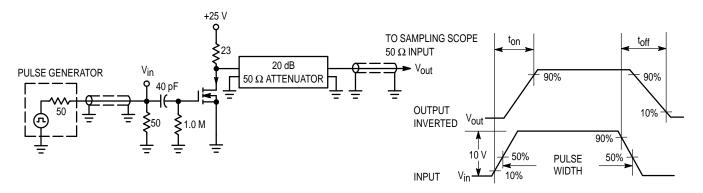
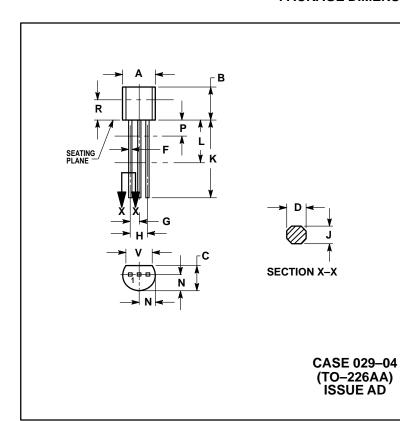


Figure 1. Switching Test Circuit

Figure 2. Switching Waveforms

PACKAGE DIMENSIONS



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. DIMENSION F APPLIES BETWEEN P AND L. DIMENSION D AND J APPLY BETWEEN L AND K MINIMUM. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.022	0.41	0.55
F	0.016	0.019	0.41	0.48
G	0.045	0.055	1.15	1.39
Η	0.095	0.105	2.42	2.66
۲	0.015	0.020	0.39	0.50
Κ	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
Ъ		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

STYLE 30:
PIN 1. DRAIN
2. GATE
3. SOURCE

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